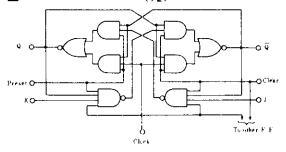
■BLOCK DIAGRAM(⅓)

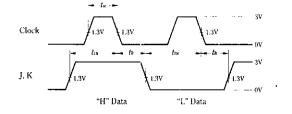


■RECOMMENDED OPERATING CONDITIONS

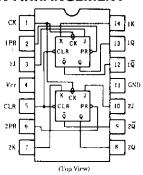
Item Clock frequency		Symbol	min	typ	max	Unit	
		felick	0	_	30	MHz	
Pulse	Clock High		20	_	_	ns	
width	Preset Low Clear	łu:	25	_	_	ns	
Setup	"H"Data		201	_		ns	
time	"L"Data	tau •	201	_	-	ns	
Hold time		ts	01	_	-	ns	

Note) ‡; The arrow indicates the falling edge.

■TIMING METHOD



■PIN ARRANGEMENT



EFUNCTION TABLE

		Outputs				
Preset	Clear	Clock	j	K	Q	Q
L	Н	×	×	×	Н	L
Н	L	×	×	×	L	Н
L.	Ĺ	×	×	×	н•	н.
Н	Н	1	L	L	Qο	Qυ
Н	Н	↓	Н	L	Н	L
Н	Н	1	L	H	L	Н
Н	Н	↓ I	Н	Н	Toggle	
Н	Н	Н	×	×	Q,	$\overline{\mathbf{Q}}_0$

Notes) H; high level, L; low level, X; irrelevant

- 1; transition from high to low level
- Q₀; level of Q before the indicated steady-state input conditions were established.
- Qo; complement of Qo or level of Q before the indicated steady-state input conditions were established.
- Toggle; each output changes to the complement of its previous level on each active transition indicated by 4.
- *; This configuration is nonstable; that is, it will not persist when preset and clear inputs return to their inactive (high)

ELECTRICAL CHARACTERISTICS ($T_a = -20 \sim +75 ^{\circ}\text{C}$)

Item		Symbol	Test Conditions		min	typ*	max	Unit
Input voltage		Vih		2.0	-	_	v	
		V_{II}				_	0.8	v
Output voltage		Voн	$V_{CC} = 4.75 \text{V}, V_{IH} = 2.7 \text{V}, V_{IL} = 0.8 \text{V}.$	$I_{OH} = -400 \mu A$	2.7	-	-	v
		Vol	$V_{CC} = 4.75 \text{V}, V_{IH} = 2 \text{V}$	Io L = 8m A	_	-	0.5	v
			$V_{IL}=0.8V$	IoL = 4mA	_	_	0.4	v
	J, K				-	_	20	
	Clear	I _{IH}	$V_{CC} = 5.25 \text{ V}, V_I = 2.7 \text{ V}$			_	120	μA
	Preset	1 ""			- 1		60	
Input current	Clock				- 1		160	
	J, K	Int**					-0.4	
	Clear		$V_{CC} = 5.25 \text{ V}, V_I = 0.4 \text{ V}$			_	-1.6	mA
	Preset				_		-0.8	
	Clock						-1.6	
	J, K		$V_{CC}=5.25$ V, $V_I=7$ V			_	0.1	mA
	Clear	$\Box_{t_{l}}$				_	0.6	
	Preset	_ **					0.3	
	Clock	7			-	_	0.8	
Short circuit output current		Ios	$V_{CC}=5.25V$		- 20		-100	mA
Supply current ***		l cc	$V_{CC} = 5.25 \text{V}$			4	6	mA
Input clamp voltage		Vik	$V_{CC} = 4.75 \text{V}, I_{IN} = -18 \text{mA}$		- 1		-1.5	v

 $VCC = 5V, Ta = 25^{\circ}C$

IIL should not be measured when preset and clear inputs are low at same time.

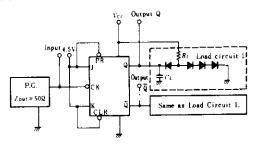
With all outputs open, ICC is measured with the Q and Q outputs high in turn. At the time of measurement, the clock input is grounded.

ESWITCHING CHARACTERISTICS ($V_{CC} = 5V$, $T_a = 25^{\circ}C$)

Item	Symbol	Inputs	Outputs	Test Conditions	min	typ	max	Unit
Maximum clock frequency	fmoz.				30	45		MHz
	<i>tpl</i> H	Clear	Q. Q	$C_L = 15 \mathrm{pF}, R_L = 2 \mathrm{k}\Omega$	-	15	20	กร
Propagation delay time	tpHL.	Preset Clock			_	15	20	ns

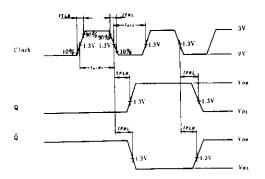
TESTING METHOD

- 1) Test Circuit
- 1.1) f=++, tPLH, tPHL {Clock→Q,Q}



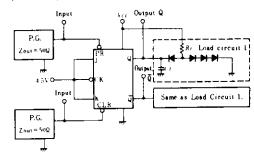
Notes) 1. Test is put into the each flip-flop

- 2. All diodes are 1S2074 (1).
- 3. C_L includes probe and jig capacitance.



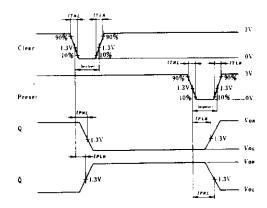
Note) Clock input pulse; $t_{TLH} \le 15$ ns, $t_{THL} \le 6$ ns, pRR = 1MHz, duty cycle=50% and: for f_{max} , $t_{TLH} = t_{THL} \le 2.5$ ns.

1.2) teht, tell (Clear, Preset →Q,Q)



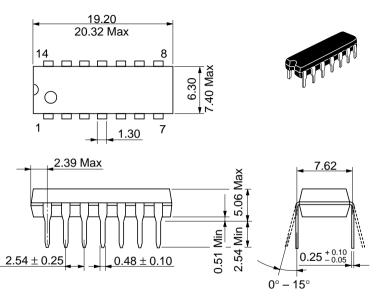
Notes) 1. Test is put into the each flip-flop

- 2. All diodes are 1S2074 (B).
- 3. C_L includes probe and jig capacitance.



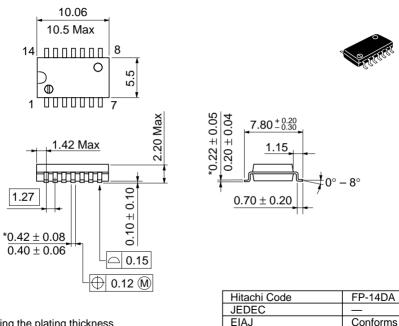
Note) Clear and preset input pulse; $t_{TLH} \le 15 \text{ ns}$, $t_{THL} \le 6 \text{ns}$, PRR = 1 MHz

Unit: mm



Hitachi Code	DP-14
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.97 g

Unit: mm

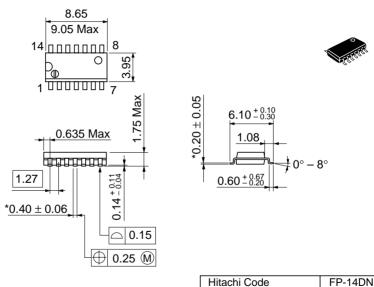


Weight (reference value)

0.23 g

*Dimension including the plating thickness
Base material dimension

Unit: mm



*Pd plating

JEDEC Conforms

EIAJ Conforms

Weight (reference value) 0.13 g

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